

# **DATA SHEET**

**GENERAL PURPOSE CHIP RESISTORS** 

RC0402 (Pb Free) 5%, 1%



**Phicomp** 

Product specification – Sep 03, 2004 V.2



#### Chip Resistor Surface Mount | RC | SERIES | 0402 (Pb Free)

#### SCOPE

This specification describes RC0402 series chip resistors with lead-free terminations made by thick film process.

#### ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

#### PHYCOMP ORDERING CODE

#### 12NC CODE

2322	XXX	XXXXX	( L
(I)	(2)	(3)	(4)

		TOL.	RESISTANCE	PAPER	R / PE TAPE ON REE	L (units) (2)
0402	IN <sup>(1)</sup>	(%)	RANGE	10,000	20,000/not preferred	50,000
RC31	2322	±5%	I to I0 M $\Omega$	705 70xxx		705 87xxx
RC32	2322	±1%	I to I0 M $\Omega$	706 7xxx		706 8xxxx
Jumper	2322	-	0 Ω	705 91001		705 91007

- (1) The resistors have a 12-digit ordering code starting with 2322.
- (2) The subsequent 4 or 5 digits indicate the resistor tolerance and packaging.
- (3) The remaining 4 or 3 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of I2NC".
- (4) "L" means lead-free terminations.

#### **ORDERING EXAMPLE**

The ordering code of a RC32 resistor, value 56  $\Omega$  with ±1% tolerance, supplied in tape of 10,000 units per reel is: 232270675609L.

Last digit of I2NC	
Resistance decade (3)	Last digit
0.01 to 0.0976 Ω	0
0.1 to 0.976 $\Omega$	7
I to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
I to 9.76 $k\Omega$	2
10 to 97.6 kΩ	3
100 to 976 $k\Omega$	4
I to 9.76 MΩ	5
10 to 97.6 MΩ	6

Example:	0.02 12	=	0200 or 200
	0.3 Ω	=	3007 or 307
	ΙΩ	=	1008 or 108
	33 kΩ	=	3303 or 333
	10 MΩ	=	1006 or 106

#### CTC CODE

RC0402	<u>X</u>	<u>X</u>	<u>X</u>	$\mathbf{XX}$	XXXX	L
	(1)	(2)	(3)	(4)	(5)	(6)

(I) TOLERANCE	
F = ±1%	
$J = \pm 5\%$	
(2) PACKAGING TYPE	

# R = Paper/PE taping reel

# (3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

#### (4) TAPING REEL

07 = 7 inch dia. Reel
10 = 10 inch dia. Reel (not preferred)
13 = 13 inch dia. Reel

#### (5) RESISTANCE VALUE

5R6, 56R, 560R, 56K, 1M.

#### (6) RESISTOR TERMINATIONS

L = Lead free terminations (pure Tin)

#### **ORDERING EXAMPLE**

The ordering code of a RC0402 chip resistor, value 56  $\Omega$  with  $\pm 1\%$  tolerance, supplied in 7-inch tape reel is: RC0402FR-0756RL.

#### NOTE

- 1. The "L" at the end of the code is only for ordering. On the reel label, the standard CTC or 12NC will be mentioned an additional stamp "LFP"= lead free production.
- 2. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- 3. Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)



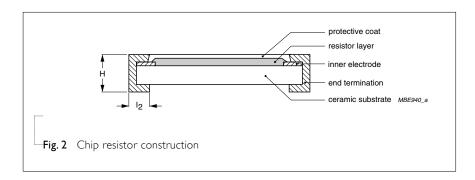
#### MARKING

#### RC0402



#### **CONSTRUCTION**

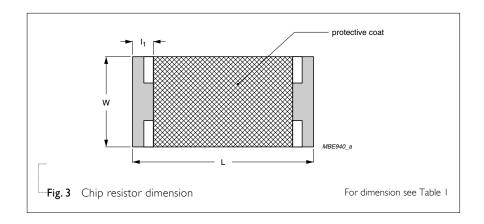
The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat.



Finally, the two external terminations (pure Tin) are added. See fig. 2.

### **DIMENSIONS**

Table I	
TYPE	RC0402
L (mm)	1.00 ±0.05
W (mm)	0.50 ±0.05
H (mm)	0.35 ±0.05
I <sub>I</sub> (mm)	0.20 ±0.10
l <sub>2</sub> (mm)	0.25 ±0.10



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#### **ELECTRICAL CHARACTERISTICS**

Table 2		
CHARACTERISTICS	R	C0402 I/I6 W
Operating Temperature Range	<b>–</b> 55	°C to +155 °C
Maximum Working Voltage		50 V
Maximum Overload Voltage		100 V
Dielectric Withstanding Voltage		100 V
	5% (E24)	Ι Ω to 10 ΜΩ
Resistance Range	1% (E96)	I $\Omega$ to I0 M $\Omega$
	Zero Ohm Ju	ımper < 0.05 Ω
Temperature Coefficient	$10 \Omega < R \le 10 M\Omega$	±100 ppm/°C
Temperature Coemcient	$1 \Omega < R \le 10 \Omega$	±200 ppm/°C
Jumper Criteria	Rated Current	I.0 A
Jumper Criteria	Maximum Current	2.0 A

# <u>FOOTPRINT AND SOLDERING</u> <u>PROFILES</u>

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

#### ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data".

#### PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC0402	Paper / PE Taping Reel (R)	7" (178 mm)	10,000 units
		10" (254 mm) / not preferred	20,000 units
		13" (330 mm)	50,000 units

#### NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.

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#### **FUNCTIONAL DESCRIPTION**

#### **POWER RATING**

RC0402 rated power at 70°C is I/I6 W

#### **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

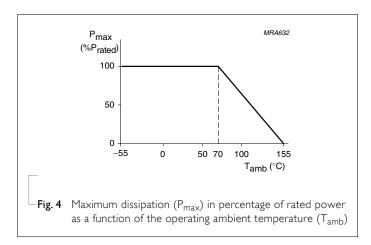
$$V=\sqrt{(P \times R)}$$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value  $(\Omega)$ 



#### **PULSE LOADING CAPABILITIES**

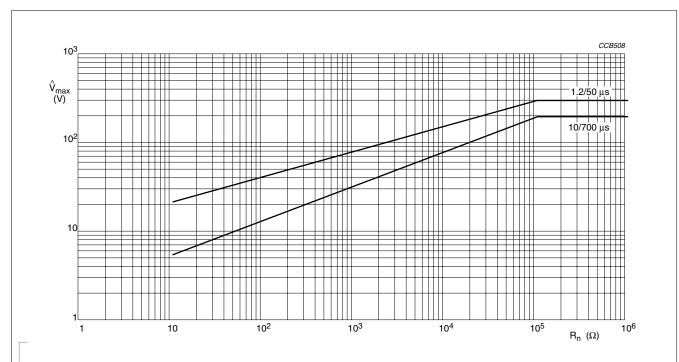


Fig. 5 Maximum permissible peak pulse voltage without failing to open circuit' in accordance with DIN IEC 60040 (CO) 533 for type: RC0402

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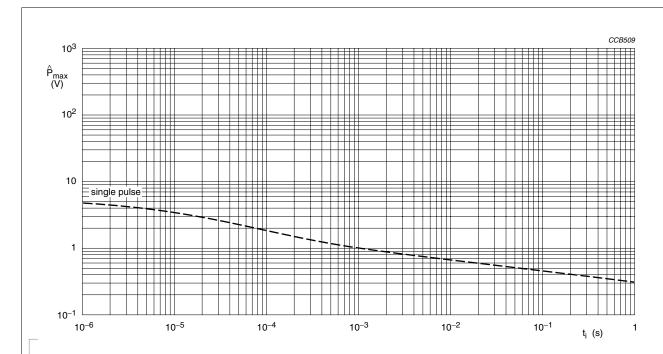


Fig. 6 Pulse on a regular basis for type: RC0402; maximum permissible peak pulse power as a function of pulse duration for single pulse and repetitive pulse tp/ti = 1000

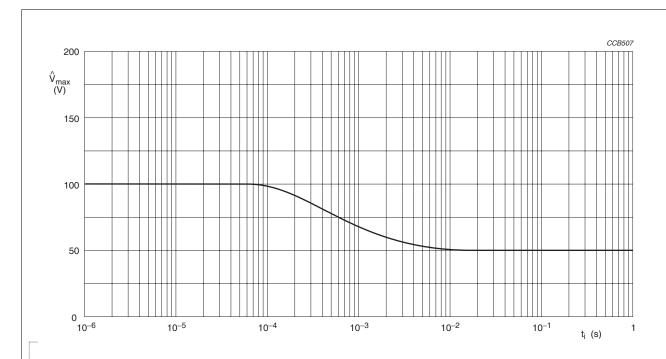


Fig. 7 Pulse on a regular basis for type: RC0402; maximum permissible peak pulse voltage as a function of pulse duration

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## TESTS AND REQUIREMENTS

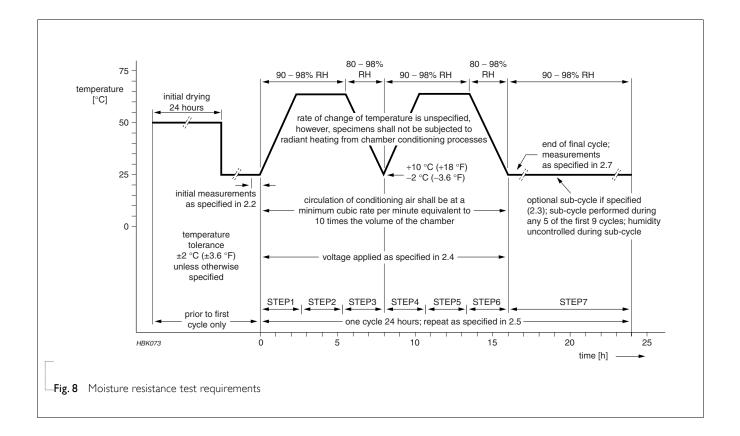
**Table 4** Test condition, procedure and requirements

ΓEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 2
Coefficient of	JIS C 5202-4.8	Formula:	
Resistance (T.C.R.)			
( ) = 1 ,		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where $t_1$ =+25 °C or specified room temperature	
		$t_2$ =-55 °C or +125 °C test temperature	
		R <sub>1</sub> =resistance at reference temperature in ohms	
		R <sub>2</sub> =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G;	At -65 (+0/-10) °C for 2 minutes and at +155	$\pm (0.5\% \pm 0.05~\Omega)$ for 1% tol.
	IEC 60115-1 4.19	(+10/-0) °C for 2 minutes; 25 cycles	$\pm (1.0\% {+} 0.05~\Omega)$ for 5% tol.
Low	MIL-R-55342D-Para 4.7.4	At -65 (+0/-5) °C for I hour; RCWV applied	$\pm$ (0.5%+0.05 Ω) for 1% tol
Temperature		for 45 (+5/–0) minutes	$\pm$ (1.0%+0.05 Ω) for 5% tol.
Operation			No visible damage
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	$\pm (1.0\% + 0.05 \ \Omega)$ for 1% tol.
Overload	IEC 60115-1 4.13	temperature	$\pm (2.0\% + 0.05 \ \Omega)$ for 5% tol.
			No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Type RC0402	
		Voltage (DC) 100 V	
Dielectric	MIL-STD-202F-method 301;	Maximum voltage (V <sub>rms</sub> ) applied for 1 minute	No breakdown or flashover
Withstand	IEC 60115-1 4.6.1.1	Type RC0402	
Voltage		Voltage (AC) 100 V <sub>rms</sub>	
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 ±5 °C for 10 ±1	$\pm$ (0.5%+0.05 Ω) for 1% tol.
Soldering	IEC 60115-1 4.18	seconds	$\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol.
Heat			No visible damage
Life	MIL-STD-202F-method 108A;	At 70±2 °C for 1,000 hours; RCWV applied for	$\pm$ (1%+0.05 $\Omega$ ) for 1% tol.
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off	$\pm (3\% + 0.05 \ \Omega)$ for 5% tol.

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ST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% cove	ered)
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage	
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy	±(1.0%+0.05 Ω) for 1%	6 tol.
Strength	IEC 60115-1 4.15	resin PCB (FR4)	$\pm (1.0\% + 0.05 \ \Omega)$ for 5%	ś tol.
		Bending: 5 mm	No visible damage	
Resistance to	MIL-STD-202F-method 215;	Isopropylalcohol (C <sub>3</sub> H <sub>7</sub> OH) or dichloromethane	No smeared	
Solvent	IEC 60115-1 4.29	(CH <sub>2</sub> Cl <sub>2</sub> ) followed by brushing		
Noise	JIS C 5202 5.9;	Maximum voltage (V <sub>ms</sub> ) applied.	Resistors range	Value
	IEC 60115-1 4.12		R < 100 Ω	I0 dB
			$100 \Omega \le R < 1 K\Omega$	20 dB
			I KΩ ≤ R < 10 KΩ	30 dB
			10 KΩ ≤ R < 100 KΩ	40 dB
			$100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega$	46 dB
			$I M\Omega \le R \le 22 M\Omega$	48 dB
Humidity	JIS C 5202 7.5;	1,000 hours; 40±2 °C; 93(+2/–3)% RH	+(0.5%+0.05. <b>0</b> ) for 1%	ć tol
Humidity (steady state)	JIS C 5202 7.5; IEC 60115-8 4.24.8	1,000 hours; 40±2 °C; 93(+2/-3)% RH RCWV applied for 1.5 hours on and 0.5 hour off	$\pm$ (0.5%+0.05 $\Omega$ ) for 1% $\pm$ (2.0%+0.05 $\Omega$ ) for 5%	
•	•	, ,		
(steady state)	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off	$\pm (2.0\% + 0.05 \ \Omega)$ for 5%	
(steady state)	IEC 60115-8 4.24.8 EIA/IS 4.13B;	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at $260\pm5$ °C Dipping time: $30\pm1$ seconds	$\pm (2.0\% + 0.05 \ \Omega)$ for 5%	ó tol.
(steady state)  Leaching	IEC 60115-8 4.24.8  EIA/IS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at $260\pm5$ °C Dipping time: $30\pm1$ seconds	$\pm (2.0\% + 0.05 \ \Omega)$ for 5% No visible damage	ś tol.
(steady state)  Leaching  Intermittent	IEC 60115-8 4.24.8  EIA/IS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at $260\pm5$ °C Dipping time: $30\pm1$ seconds  At room temperature; $2.5 \times$ RCWV applied for 1 second on and 25 seconds off; total 10,000	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1%	ś tol.
Leaching  Intermittent Overload  Resistance to	IEC 60115-8 4.24.8  EIA/IS 4.13B; IEC 60115-8 4.18  JIS C 5202 5.8	RCWV applied for 1.5 hours on and 0.5 hour off  Solder bath at 260±5 °C  Dipping time: 30±1 seconds  At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000 cycles	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1%	6 tol. 6 tol. 6 tol.
Leaching  Intermittent Overload  Resistance to Vibration	IEC 60115-8 4.24.8  EIA/IS 4.13B; IEC 60115-8 4.18  JIS C 5202 5.8  On request	RCWV applied for 1.5 hours on and 0.5 hour off  Solder bath at 260±5 °C  Dipping time: 30±1 seconds  At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000 cycles  On request	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1% $\pm (2.0\% + 0.05~\Omega)$ for 5%	6 tol. 6 tol. 6 tol.

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# REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Sep 03, 2004	-	- New datasheet for 0402 thick film 1% and 5% with lead-free terminations
			- Replace the 0402 part of pdf files: RC01_11_21_31_5, RC02_12_22_32_10
			- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)